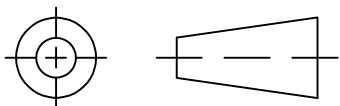


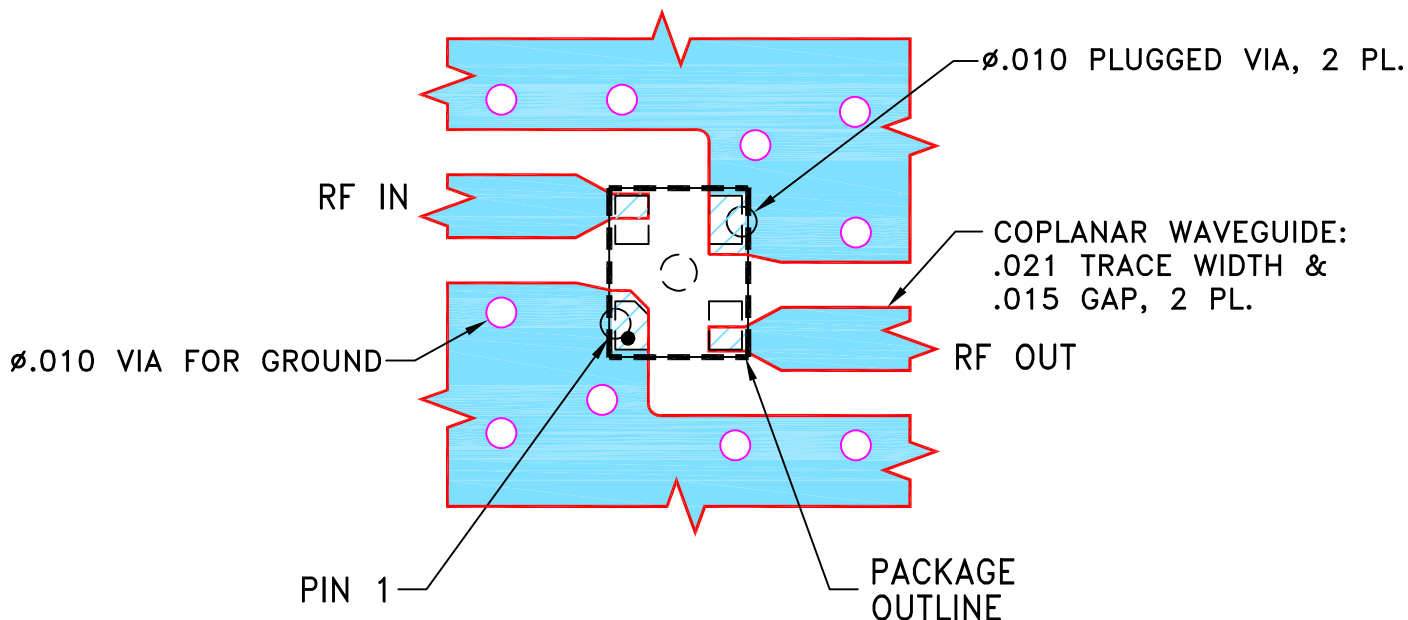
THIRD ANGLE PROJECTION



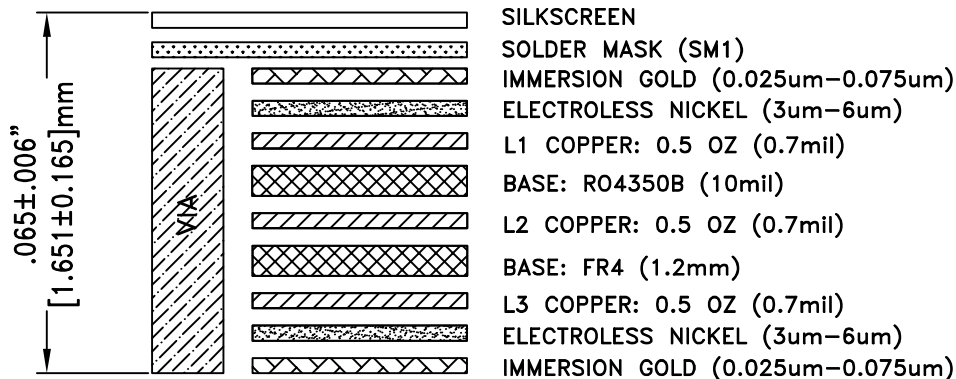
REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-018788	NEW RELEASE	08/07/23	ITG	IL

SUGGESTED MOUNTING CONFIGURATION
FOR TE2769 CASE STYLE

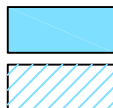


3 LAYER STACK-UP DIAGRAM



NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .010"; COPPER: 1/2 OZ EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYERS L2 & L3 OF THE PCB ARE CONTINUOUS GROUND PLANES.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	08/07/23
TOLERANCES ON:	CHECKED	GF	08/07/23
2 PL DECIMALS ±	APPROVED	IL	08/07/23
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

Mini-Circuits[®] 13 Neptune Avenue
Brooklyn NY 11235

PL,TE2769,TB-TAV1-331NM+/541NM+

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-758	OR
FILE:	98PL758	SCALE: 15:1	SHEET: 1 OF 1